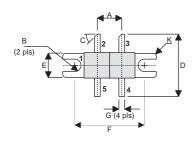
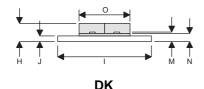


D1222UK

ROHS COMPLIANT METAL GATE RF SILICON FET

MECHANICAL DATA





SOURCE (COMMON) PIN 2 PIN 1 DRAIN 1 PIN 3 DRAIN 2 PIN 4 GATE 2

PIN 5 GATE 1

DIM	mm	Tol.	Inches	Tol.
Α	6.45	0.13	0.254	0.005
В	1.65R	0.13	0.065R	0.005
С	45°	5°	45°	5°
D	16.51	0.76	0.650	0.03
Е	6.47	0.13	0.255	0.005
F	18.41	0.13	0.725	0.005
G	1.52	0.13	0.060	0.005
Н	4.82	0.25	0.190	0.010
- 1	24.76	0.13	0.975	0.005
J	1.52	0.13	0.060	0.005
K	0.81R	0.13	0.032R	0.005
М	0.13	0.02	0.005	0.001
N	2.16	0.13	0.085	0.005

GOLD METALLISED MULTI-PURPOSE SILICON DMOS RF FET 60W - 12.5V - 175MHz**PUSH-PULL**

FEATURES

- SIMPLIFIED AMPLIFIER DESIGN
- SUITABLE FOR BROAD BAND APPLICATIONS
- LOW C_{rss}
- SIMPLE BIAS CIRCUITS
- LOW NOISE
- HIGH GAIN 10 dB MINIMUM

APPLICATIONS

 HF/VHF/UHF COMMUNICATIONS from 1 MHz to 500 MHz

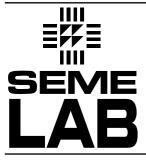
ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

P_{D}	Power Dissipation	290W
BV_DSS	Drain – Source Breakdown Voltage *	40V
BV_GSS	Gate – Source Breakdown Voltage *	±20V
I _{D(sat)}	Drain Current*	30A
T _{stg}	Storage Temperature	−65 to 150°C
Tj	Maximum Operating Junction Temperature	200°C

^{*} Per Side

Semelab PIc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.

Website: http://www.semelab.co.uk



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ELECTRICAL CHARACTERISTICS (T_{case} = 25° C unless otherwise stated)

Parameter		Test Conditions		Min.	Тур.	Max.	Unit
PER SIDE							
BV _{DSS}	Drain-Source	V _{GS} = 0	I _D = 100mA	40			V
	Breakdown Voltage	VGS - 0		40			V
I _{DSS}	Zero Gate Voltage	V _{DS} = 12.5V	V _{GS} = 0			1	A
	Drain Current					I	mA
I _{GSS}	Gate Leakage Current	V _{GS} = 20V	V _{DS} = 0			1	μА
V _{GS(th)}	Gate Threshold Voltage*	I _D = 10mA	$V_{DS} = V_{GS}$	1		7	V
9 _{fs}	Forward Transconductance*	V _{DS} = 10V	I _D = 3A	2.4			mhos
		TOTAL	DEVICE				
G _{PS}	Common Source Power Gain	P _O = 60W		10			dB
η	Drain Efficiency	V _{DS} = 12.5V	$I_{DQ} = 2.4A$	50			%
VSWR	Load Mismatch Tolerance	f = 175MHz		20:1			_
		PER	SIDE				
C _{iss}	Input Capacitance	$V_{DS} = 0V \qquad V_{GS}$	_S = -5V f = 1MHz			180	pF
C _{oss}	Output Capacitance	$V_{DS} = 12.5V V_{GS}$	S = 0 $f = 1MHz$			120	pF
C _{rss}	Reverse Transfer Capacitance	$V_{DS} = 12.5V V_{GS}$	s = 0 f = 1MHz			12	pF

^{*} Pulse Test: Pulse Duration = 300 μs , Duty Cycle \leq 2%

HAZARDOUS MATERIAL WARNING

The ceramic portion of the device between leads and metal flange is beryllium oxide. Beryllium oxide dust is highly toxic and care must be taken during handling and mounting to avoid damage to this area.

THESE DEVICES MUST NEVER BE THROWN AWAY WITH GENERAL INDUSTRIAL OR DOMESTIC WASTE.

THERMAL DATA

R _{THj-case}	Thermal Resistance Junction – Case	Max. 0.6° C / W
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